

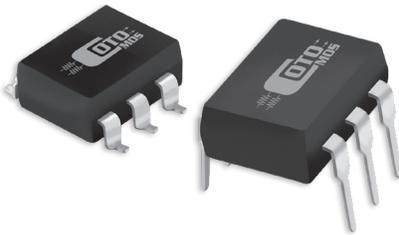
## 1 Description

Coto's new S117X Silicon Carbide (SiC) MOSFET relay supports and sustains load voltages of 1700 V while carrying a current of up to 170 mA. Advantages of the S117X SiC Relay include low switching loss, high breakdown voltage, low RdsON resistance. The extreme durability of the SiC material ensures stable performance in volatile environments under variable humidity, across a wide temperature range. Ideal applications include those requiring high voltage, high temperature and high frequency features. Target markets include Battery Management Systems, Factory Automation Control, EV Charging stations and Solar Inverters & Smart Grids.

## Device Information

| Part Series | Package           | Body Size (mm)  |
|-------------|-------------------|-----------------|
| S117T       | DIP Thru-Hole     | 8.8 x 6.4 x 3.4 |
| S117S       | DIP Surface Mount | 8.8 x 6.4 x 3.4 |

## Device Package



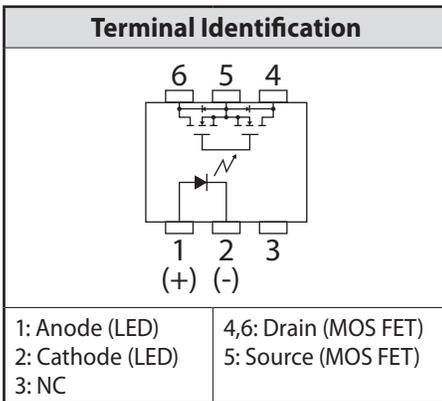
## 2 Features

- ▶ Contact Form: 1A
- ▶ Load Voltage: 1700V (AC Peak or DC)
- ▶ Load Current: 120 mA
- ▶ Low ON-Resistance: 20Ω Maximum
- ▶ Low Off-State Leakage Current: 1µA Maximum
- ▶ Package Type: 6-DIP or SMD
- ▶ Silicon Carbide FET Output

## 3 Applications

- ▶ Battery Management Systems
- ▶ Factory Automation Control
- ▶ EV Charging Stations
- ▶ Solar Inverters & Smart Grids

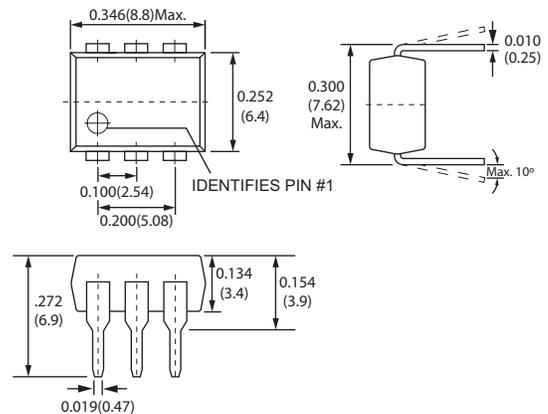
## 4 Device Schematic



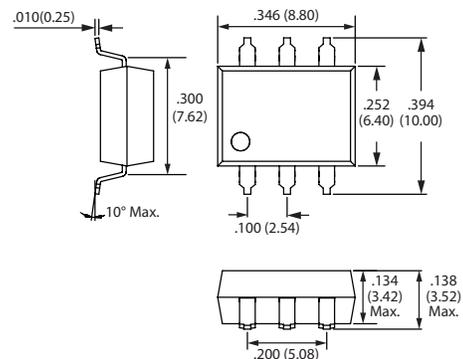
## 5 DIMENSIONS

*in Inches (Millimeters)*

### S117T (Thru-Hole)



### S117S (Surface Mount)



## 6 Specifications

### 6.1 Absolute Maximum Ratings

| Parameters  |                                    | Symbol     | Rating      | Unit              |
|---|------------------------------------|------------|-------------|-------------------|
| Input   | Continuous LED Current             | $I_F$      | 50          | mA                |
|   | Peak LED Current (f=100Hz Duty=1%) | $I_{FP}$   | 1000        | mA                |
|   | LED Reverse Voltage                | $V_R$      | 5           | V                 |
|   | Input Power Dissipation            | $P_{IN}$   | 75          | mW                |
| Output  | Load Voltage                       | $V_L$      | 1700        | V (AC Peak or DC) |
|   | Load Current                       | A (AC)     | 120         | mA                |
|   |                                    | B (DC)     | 150         | mA                |
|   |                                    | C (DC)     | 170         | mA                |
|   | Peak Load Current 100 ms (1 pulse) | $I_{PEAK}$ | 600         | mA                |
| Output Power Dissipation                              | $P_{OUT}$                          | 450        | mW          |                   |
| Total Power Dissipation                               |                                    | $P_T$      | 500         | mW                |
| I/O Breakdown Voltage (RH = 60%, 1 min)               |                                    | $V_{I/O}$  | 3750        | Vrms              |
| I/O Breakdown Voltage (Suffix-V)<br>(RH = 60%, 1 min) |                                    | $V_{I/O}$  | 5000        | Vrms              |
| Operating Temperature                                 |                                    | $T_{OPR}$  | -40 to +85  | °C                |
| Storage Temperature                                   |                                    | $T_{STG}$  | -40 to +100 | °C                |
| Pin Soldering Temperature (10 sec max)                |                                    | $T_{SOL}$  | 260         | °C                |

### 6.2 Electrical Characteristics

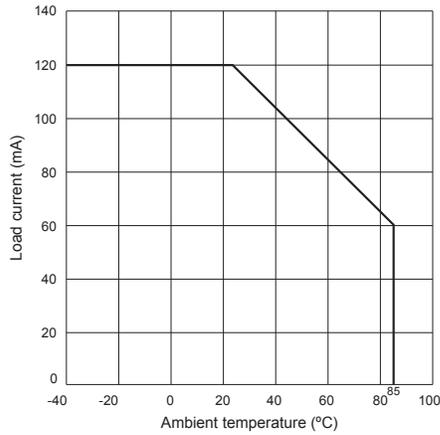
| Parameters        |                           | Symbol     | Conditions   | Min.      | Typ. | Max. | Unit     |
|-------------------|---------------------------|------------|--|-----------|------|------|----------|
| Input             | LED Forward Voltage       | $V_F$      | $I_F=10mA$   |           | 1.3  | 1.5  | V        |
|                   | Operation LED Current     | $I_{FON}$  |  |           | 1.0  | 5.0  | mA       |
|                   | Recovery LED Voltage      | $V_{FOFF}$ |  | 0.7       |      |      | V        |
|                   | Recovery LED Current      | $I_{FOFF}$ |  |           | 0.35 | 0.8  | mA       |
| Output            | On-Resistance             | $R_{ON}$   | $I_F=10mA, I_L=Rating,$<br>Time to flow is<br>within 1 sec |           | 15   | 20   | $\Omega$ |
|                   |                           |            | $I_F=10mA, I_L<5mA$  |           | 7.5  | 10   | $\Omega$ |
|                   | Off-State Leakage Current | $I_{LEAK}$ | $V_L=Rating$   |           |      | 1    | $\mu A$  |
|                   | Output Capacitance        | $C_{OUT}$  | $V_L=0, f=1MHz$  |           | 20   |      | pF       |
| Trans-<br>mission | Turn-On Time              | $T_{ON}$   | $I_F=10mA, I_L=Rating$                                     |           | 0.15 | 0.5  | ms       |
|                   | Turn-Off Time             | $T_{OFF}$  |  |           | 0.04 | 0.1  | ms       |
| Coupled           | I/O Insulation Resistance | $R_{I/O}$  | DC500V   | $10^{10}$ |      |      | $\Omega$ |
|                   | I/O Capacitance           | $C_{I/O}$  | f=1MHz   |           | 0.8  | 1.5  | pF       |

#### Environmental Ratings:

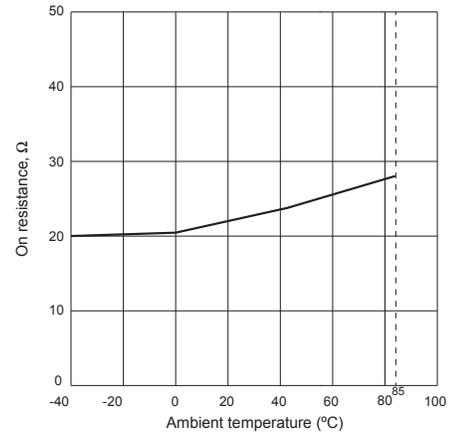
All electrical parameters measured at 25°C unless otherwise specified.

## 7 CotoMOS® S117X Series Graphs

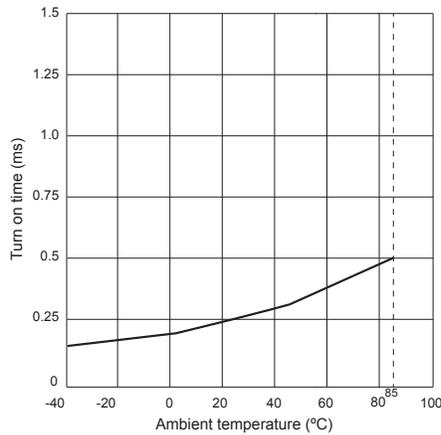
**Load Current Vs. Ambient Temperature**



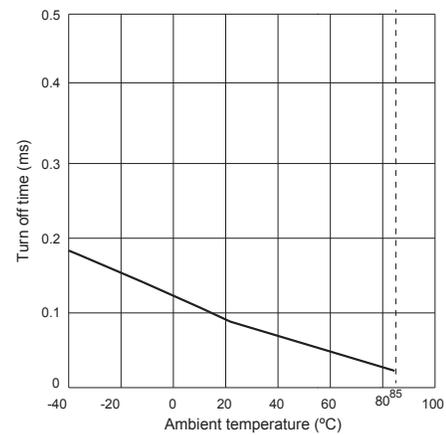
**On-Resistance Vs. Ambient Temperature**



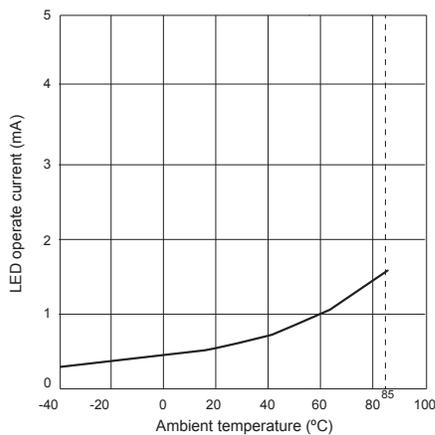
**Turn-On Time Vs. Ambient Temperature**



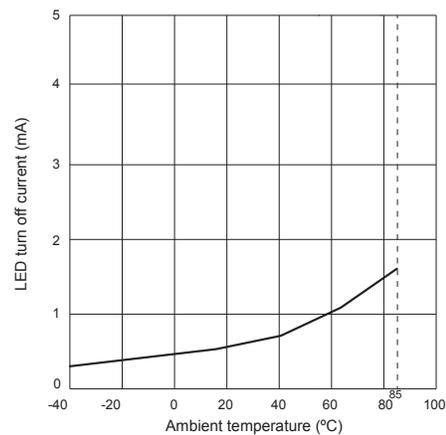
**Turn-Off Time Vs. Ambient Temperature**



**LED Operate Current Vs. Ambient Temperature**

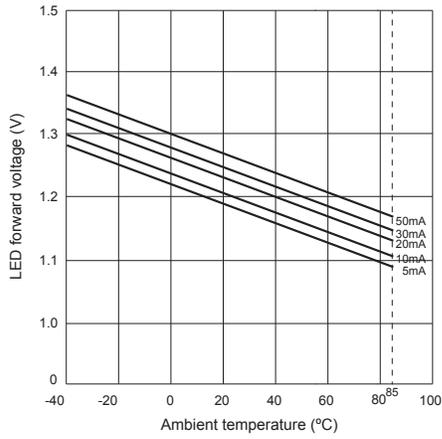


**LED Turn-Off Current Vs. Ambient Temperature**

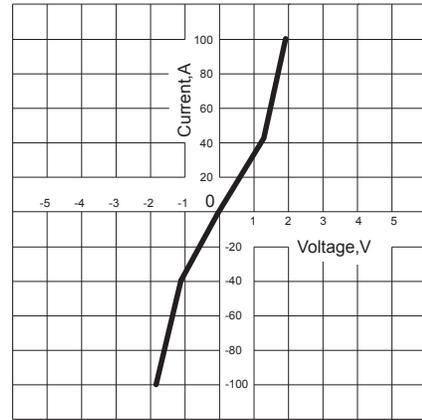


## 7 CotoMOS® S117X Series Graphs

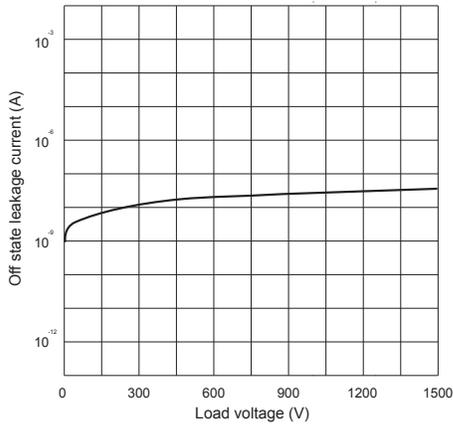
**LED Forward Voltage Vs. Ambient Temperature**



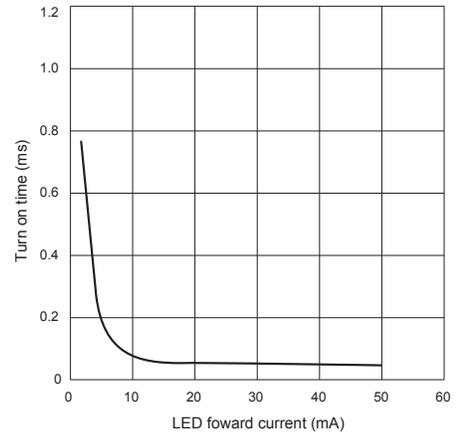
**Voltage Vs. Current Characteristics of Output at MOSFET Portion**



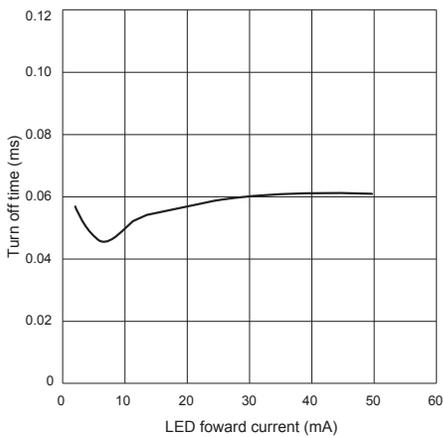
**Off-State Leakage Current Vs. Load Voltage**



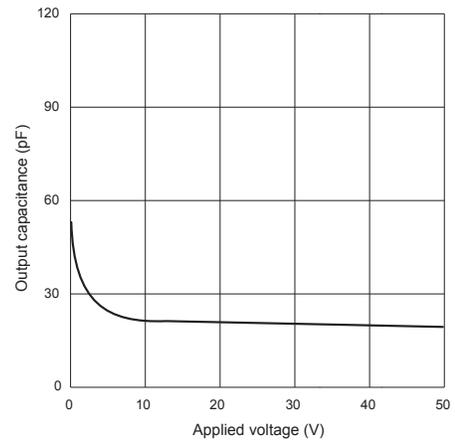
**Turn-On Time Vs. LED Forward Current**



**Turn-Off Time Vs. LED Forward Current**

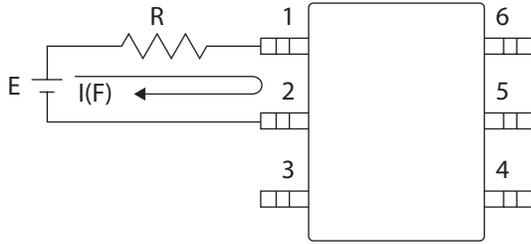


**Output Capacitance Vs. Applied Voltage**



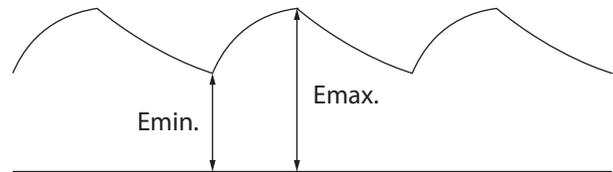
## 8 Using Methods

Examples of resistance value to control LED forward current ( $I_f=5\text{mA}$ )



| E    | R                     |
|------|-----------------------|
| 3.3V | Approx. 333 $\Omega$  |
| 5V   | Approx. 640 $\Omega$  |
| 12V  | Approx. 1.9K $\Omega$ |
| 15V  | Approx. 2.5K $\Omega$ |
| 24V  | Approx. 4.1K $\Omega$ |

- LED forward current must be more than 5mA, at E min.
- LED forward current must be less than 50mA, at E max.



## 9 Connections

Regulate the spike voltage generated on the inductive load as follows:

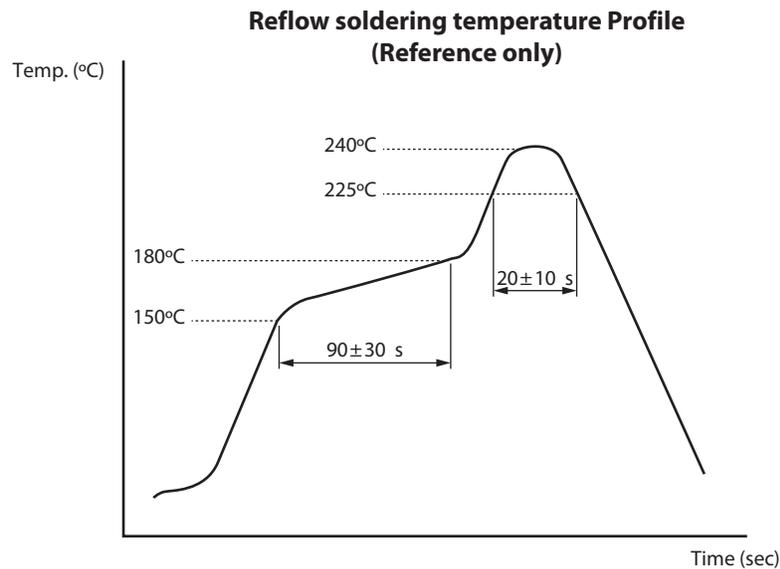
| CONNECTIONS                                   |  |  |
|---|--|--|
| <p><b>A</b> Control bi-directional signal</p> | <p><b>B</b> On-Resistance is 1/2 of A-connection</p> | <p><b>C</b> On-Resistance is 1/2 of B-connection</p> |

## 10 Recommended Soldering Conditions

### 10.1 Infrared Reflow Soldering

- ▶ Peak reflow soldering: 240°C or below (package surface temperature)
- ▶ Time of peak reflow temperature: 20-30 seconds
- ▶ Time of temperature higher than 240°C: 30-60 seconds
- ▶ Time to preheat temperature from 180~190°C: 90-120 seconds
- ▶ Number of reflows: One
- ▶ Flux: Rosin flux containing small amount of chlorine  
(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### 10.2 Recommended Temperature Profile of Infrared Reflow

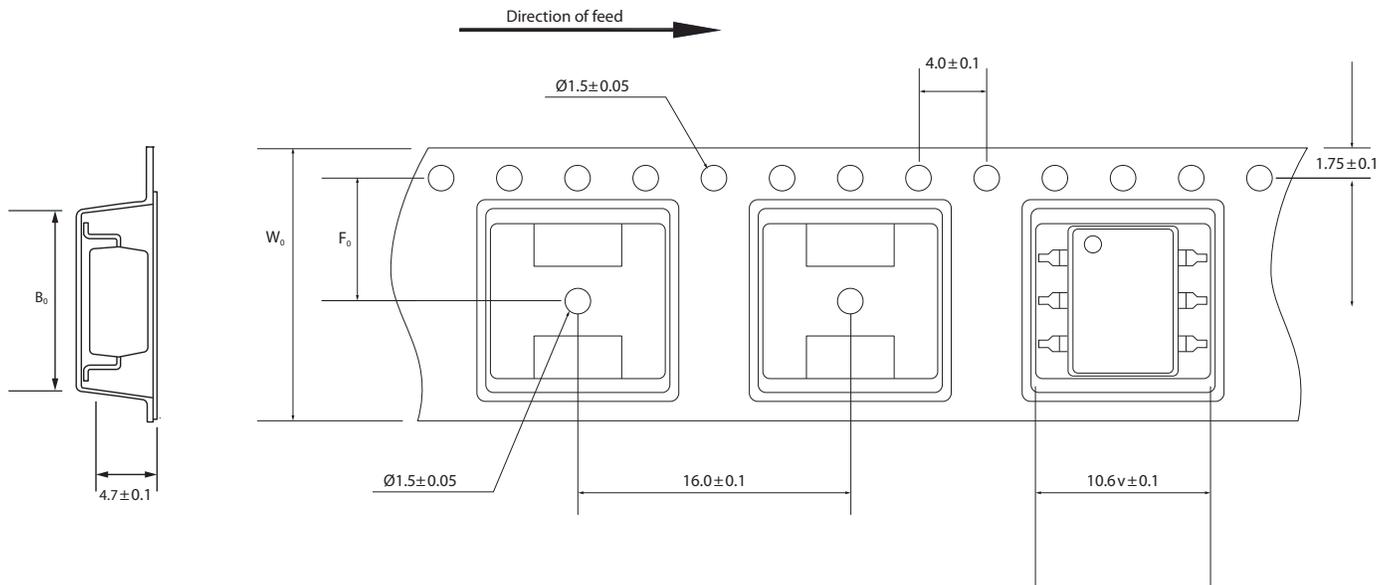
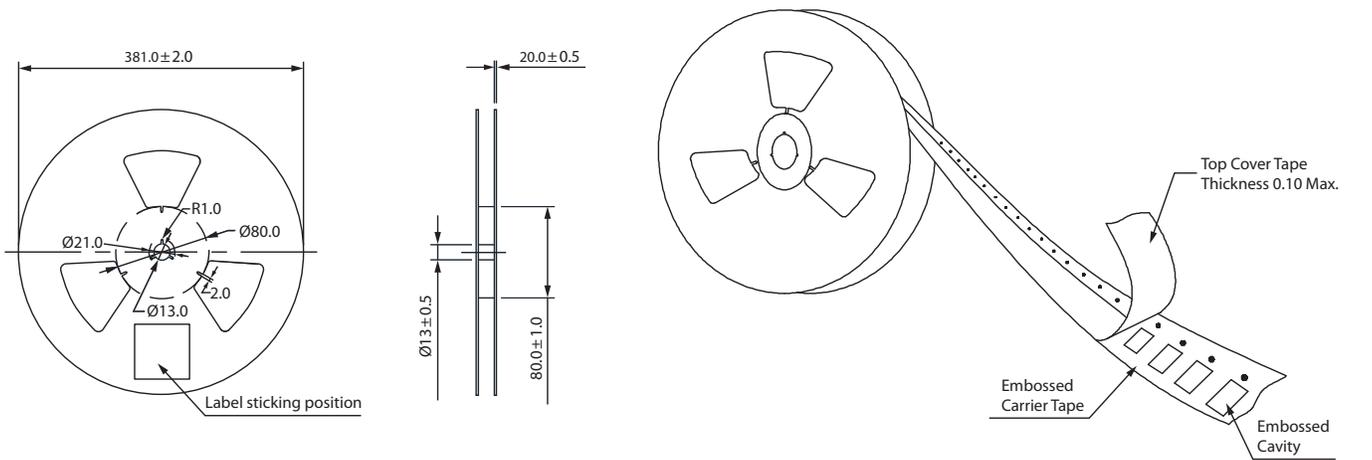


### 10.3 Cautions

- ▶ Fluxes: Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- ▶ Avoid shorting between portion of frame and leads.

## 11 CotoMOS Relay Packaging Information (Surface Mount Only)

### 11.1 6-pin SOP Carrier Tape & Reel Units: mm



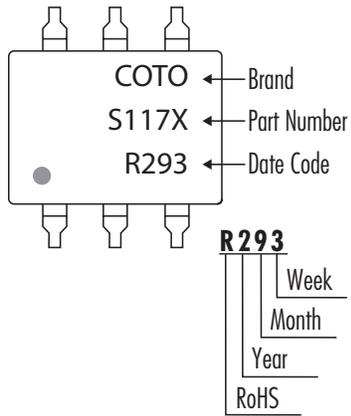
Unit: mm

| TYPE | $B_0 \pm 0.1$ | $F_0 \pm 0.1$ | $W_0 \pm 0.1$ | 15" REEL/PCS |
|------|---------------|---------------|---------------|--------------|
| 6P   | 9.4           | 7.5           | 16            | 1000         |

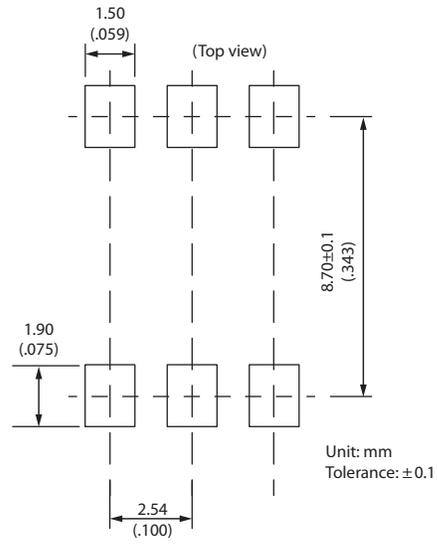
#### Notes

1. There is a leader of 230mm minimum which consists of carrier and/or cover tape followed by a minimum of 160mm of carrier tape sealed with cover tape.
2. There is a minimum of 160mm of empty component pockets sealed with cover tape.
3. Device pockets are in accordance with EIA standard EIA-481-A and specifications provided above.

### 11.2 Device Marking



### 11.3 Recommended Mounting Pad



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